

SG-FWLP-9-2

Overview

General Information

Package Material	SG
Package Family	FWLP
Leads/Balls	9
Dash Version	2

Outline

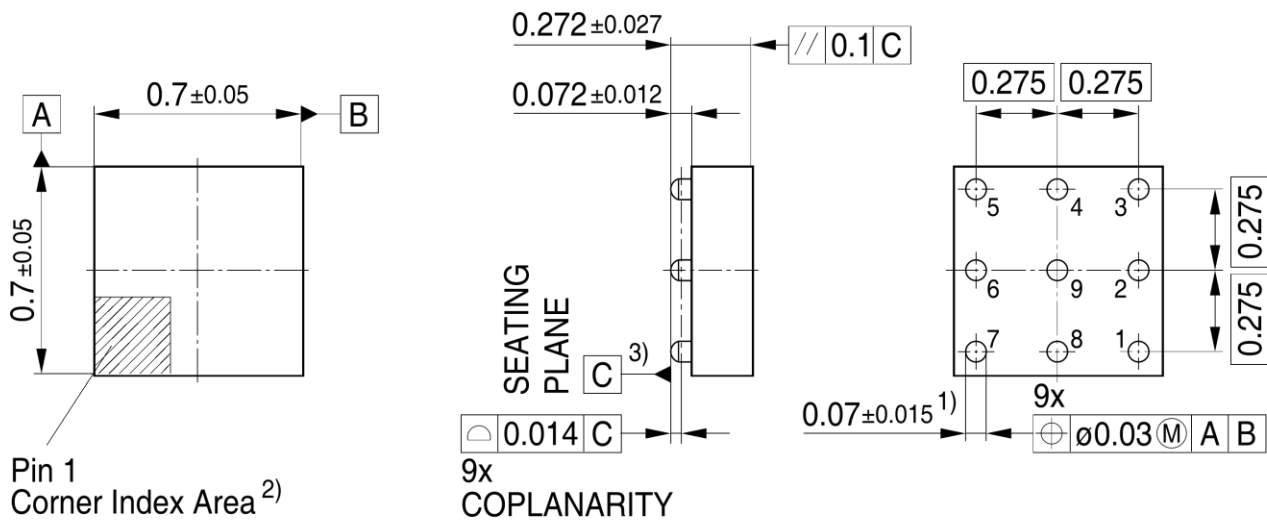
Dimensions

Body Length (mm)	0.7050
Body Width (mm)	0.7050
Lead/Ball Pitch (mm)	0.2750

Exposed Pad

Heatslug	NONE
Exposed Paddle	NONE

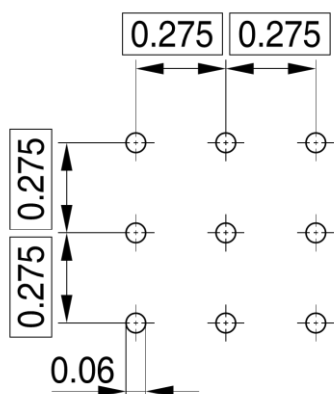
Outline



- 1) Dimension is measured at the maximum solder ball diameter, parallel to primary datum C
- 2) Pin1 corner identified by marking
- 3) Primary datum C and seating plane are defined by the domed crowns of the balls

FWLP-9-2-PO V03

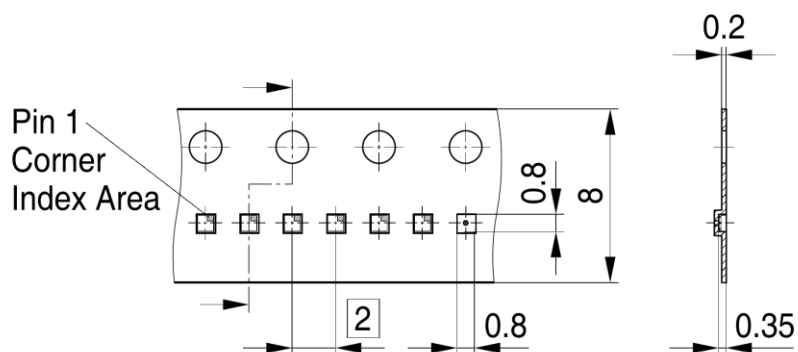
Footprint Dimensions



FWLP-9-2-FP V03

Packing

Tape & Reel



FWLP-9-2-TP V01

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Document reference

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